

HTM® 552

Maleic Anhydride Grafted Polymer

Cytec Industries Inc.

Message:

HTM® 552 is a bismaleimide resin matrix formulation that combines high temperature end-use performance with good handleability during lay-up. HTM552 has been developed for use in structures where critical load-bearing performance is required at temperatures greater than 200°C (392°F). In applications where components may be lightly loaded, intermittent periods at 250°C (482°F) can be sustained. HTM552 is also capable of enduring very short-term exposure to a temperature of 280°C (536°F).

General Information		
Features	Good Processability	
	High Flow	
	High Heat Resistance	
Uses	Structural Parts	
Forms	Fabric	
Physical	Nominal Value	Unit
Specific Gravity ¹	1.21	g/cm³
NOTE		
1.	Cured resin	

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Recommended distributors for this material


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